

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t1303cn8-5#pbf

(Engineering Calculation)

PDIP

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TOTAL MASS (g) : 0.501007

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003680	1000000	7345.20214844		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.149760	975000	298917.78125		
		Iron (Fe)	7439-89-6	0.003686	24000	7357.17773438		
		Phosphorus (P)	7723-14-0	0.000046	300	91.8150253296		
		Zinc (Zn)	7440-66-6	0.000108	700	215.565719604		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.153600	1000000	306582.375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.012410	1000000	24770.6777344		
		External Plating Total:				0.012410	1000000	24770.6777344
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001228	1000000	2451.06201172		
Internal Plating Total:				0.001228	1000000	2451.06201172		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001052	750000	2099.76977539		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000351	250000	700.588562012		
Die Attach Total:				0.001403	1000000	2800.3581543		
Encapsulation	FILLED EPOXY RESIN	Resin (EP)		0.078816	240000	157315.0625		
		Bromine (Br)	40039-93-8	0.003284	10000	6554.79443359		
		Silica (SiO2)	60676-86-0	0.236448	720000	471945.21875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.009852	30000	19664.3828125		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000000	0	0		
		Encapsulation Total:				0.328400	1000000	655479.4375
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000286	1000000	570.849914551		
					TOTAL MASS (g) :	0.501007		